



Recent Advances in Intelligent Vehicular Networks and Communications

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Message from the Guest Editors

Dear Colleagues,

This Special Issue aims to provide a platform for sharing state-of-the-art research and development on intelligent vehicular networks and communications. Potential topics include, but are not limited to, the following:

1. Vehicular system architecture design;
2. Medium access control protocols in intelligent vehicular networks;
3. Communication and network protocols in intelligent vehicular networks;
4. Vehicle-to-vehicle/roadside/Internet communication;
5. Artificial intelligence in intelligent vehicular networks;
6. Mobility management and resource allocation in intelligent vehicular networks;
7. Collaborative computing strategies for intelligent vehicular networks;
8. Security, privacy, and trust issues of intelligent vehicular networks;
9. Hardware and software design for intelligent vehicular networks;
10. Implementation and testbed of intelligent vehicular networks;
11. Blockchain-enabled vehicular networks;
12. Intent-driven network and service management for smart vehicular communication terminals.





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Message from the Editor-in-Chief

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